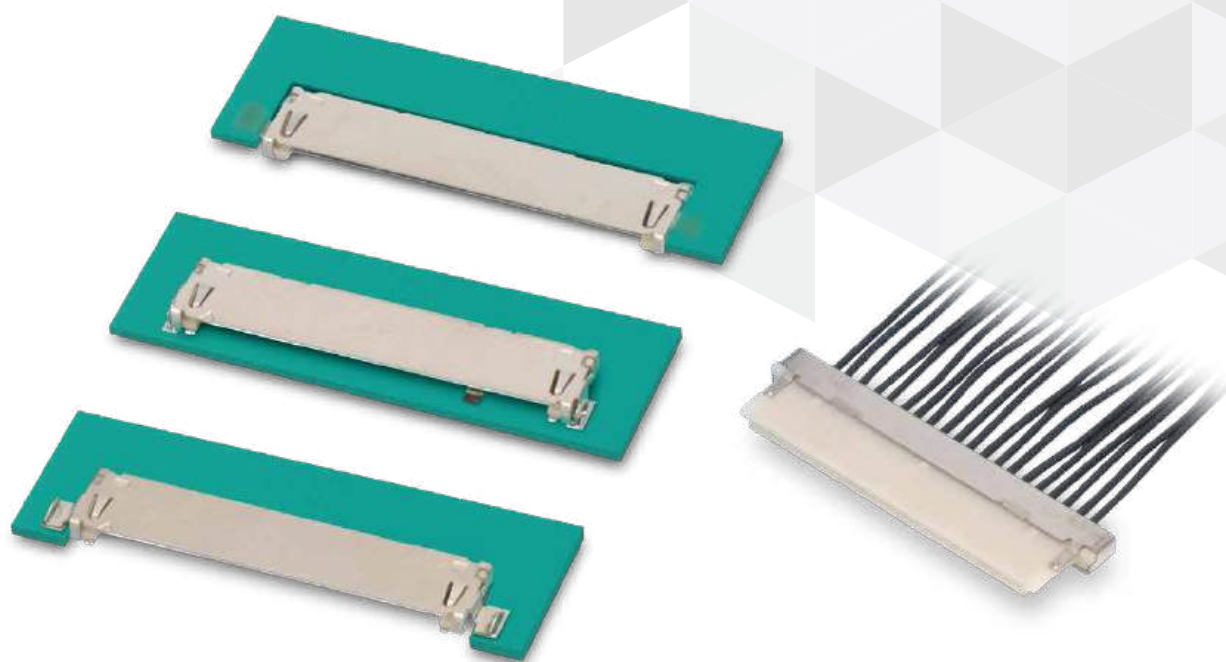


DF19 Series

1.0mm Pitch, Low Profile Wire-to-Board Connectors



Low Profile



Features

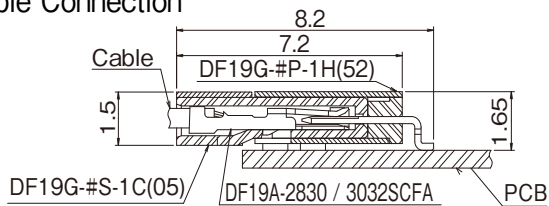
1. De Facto Standard for LCD Panel Connection

DF19 has been accepted as the market standard for LCD panels (12in. or less) due to its high performance for LVD high speed differential signals.

2. Low Profile Design

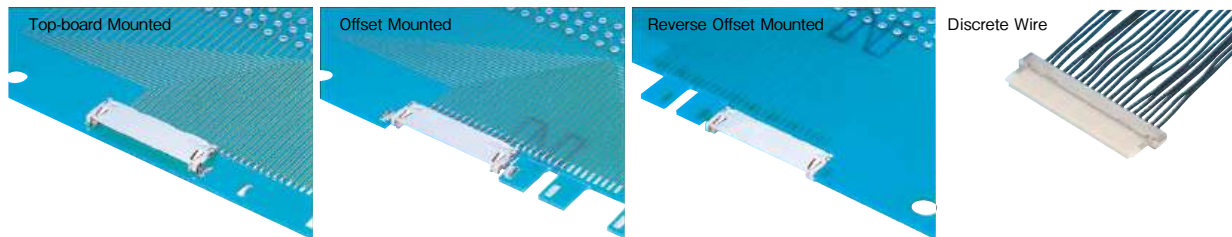
Cable type: 1.5mm thickness (1.6mm Max.)

Cable Connection



3. Wide Varieties

Header is available in top-board, offset and reverse mount offset styles to meet a wide array of application needs.



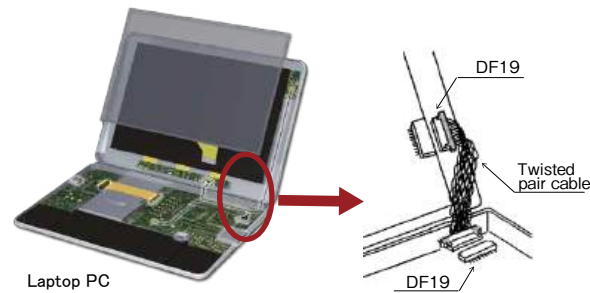
4. Ground Connection with Outer Shell

Metal shell enables ground connection.

5. Glow Wire Compatible (IEC60695-2-11 Standard)

Applications

Mobile phones, LCD connections, DVC, DSC, PDA, camera modules, and other small equipment



Product Specifications

Rated Current	28 AWG	30 AWG	32 AWG	Operating Temperature (Note 1)	-35 to +85℃
	1A/pin	0.9A/pin	0.8A/pin	Operating Humidity Range (Note 2)	40 to 80%
Rated Voltage	100V AC/DC			Storage Temperature Range (Note 3)	-10 to +60℃
				Storage Humidity Range (Note 3)	40 to 70%

Note 1: Includes temperature rise due to current flow.
Note 2: Please use without condensation.
Note 3: Applicable to unused items in packaged state.
Note 4: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Item	Specification	Conditions
Insulation Resistance	500M Ω Min.	100V DC
Withstanding Voltage	No flashover or insulation breakdown.	300V AC for 1 min.
Contact Resistance	30m Ω Max.	1mA
Vibration	No electrical discontinuity of 1 μ s or more.	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, in 3 direction for 10 cycles
Humidity (Steady State)	Contact Resistance: 30m Ω Max. Insulation Resistance: 500M Ω Min.	96 hours at temperature of 40 $\pm$ 2℃ and humidity of 90 to 95%
Temperature Cycle	Contact Resistance: 30m Ω Max. Insulation Resistance: 500M Ω Min.	Temperature: -55℃ $\rightarrow$ +5 to +35℃ $\rightarrow$ +85℃ $\rightarrow$ +5 to +35℃ Time (Minutes): 30 $\rightarrow$ 10 $\rightarrow$ 30 $\rightarrow$ 10 for 5 cycles
Mating Durability	Contact Resistance: 30m Ω Max.	30 cycles
Soldering Heat Resistance	No deformation of the insulator parts affecting performance.	Re-flow soldering: At the recommended temperature profile Manual soldering: Soldering iron temperature 350℃, 5 seconds

Materials / Finish

Product	Component	Material	Finish / Color	Remarks	RoHS2
Pin Header	Insulator	Polyamide	Black or Beige	UL94V-0	○
	Contacts	Phosphor Bronze	Partially Gold Plated	-	
	Exterior Shell	Phosphor Bronze	Partially Tin Plated	-	
Crimp Case	Insulator	Polyamide	Beige	UL94V-0	
	Exterior Shell	Stainless Steel	Tin Plated	-	
Socket Crimp Contact	Contact	Phosphor Bronze	Gold Plated	-	

Product Number Structure

Refer to the chart below when determining the product specifications from the product number.
Please select from the product numbers listed in this catalog when placing orders.

Connector

DF19 # - # P - 1 H (52)
1 2 3 4 5 6 8

DF19 # - # S - 1 F - GND
1 2 3 4 5 6 7

1 Series Name	DF19	3 No. of Pos.	8, 14, 20, 30 (Note)
2 Configuration	Pin Header G: Top-board Mouted (1.65mm Height) K: Offset Mounted (1.0mm Height) L: Offset Mounted (1.1mm Height) KR: Reverse Offset Mounted Version of DF19K (1.0mm Height) Crimp Socket Blank: No Exterior Shell G: With Exterior Shell (EMI Prevention Specification)	4 Connector Type	S: Single Row Socket P: Single Row Pin Header
		5 Contact Pitch	1.0mm
		6 Mounting Type/ Termination Type	H: Right Angle SMT C: Crimp Case
		7 Specification	(52): Gold plated, tape & reel packaging

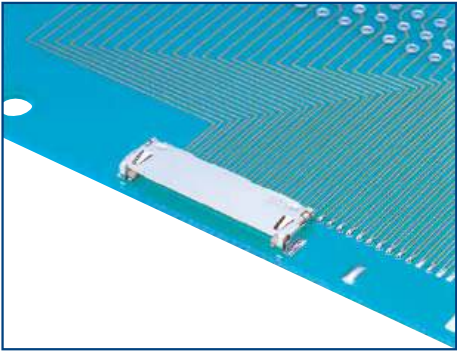
Note: The pin count availabilities vary based on connection style.

Crimp Contact

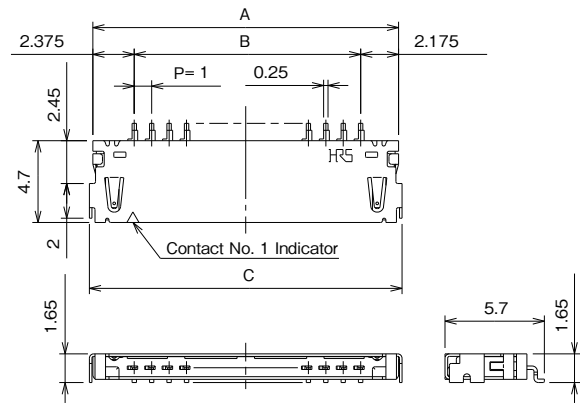
DF19A - 2830 SCF A (##)
1 2 3 4

1 Conductor Size	2830: 28-30 AWG 3032: 30-32 AWG	3 Plating	A: Gold Plated
2 Contact Type/ Packaging	SCF: Socket Contact, Reel	4 Packaging	Blank: 10,000pcs per reel (41): 20,000pcs per reel

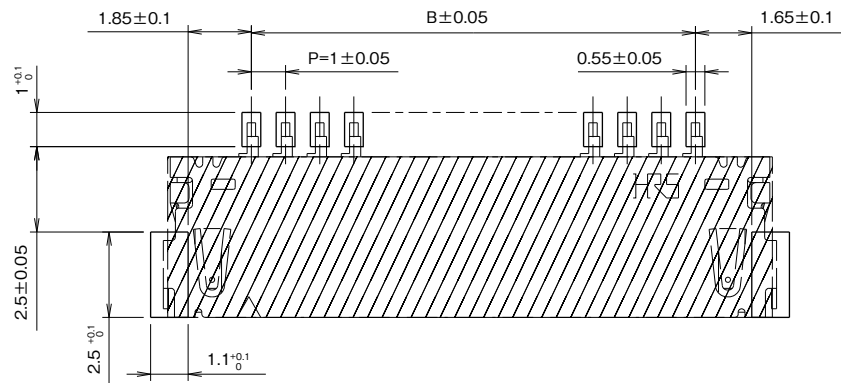
Right Angle Pin Header (SMT) (Top-Board Mounted Type)



Pictured mounted on board.



Recommended PCB Mounting Pattern

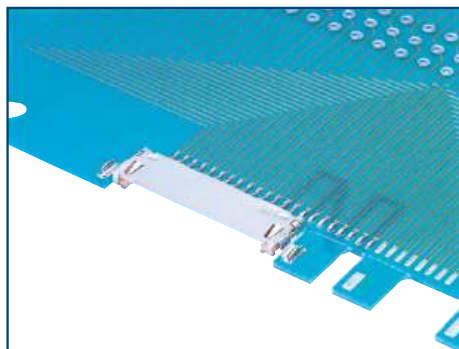


Note: If there is a pattern on the  portion and resist is not applied, it may come into contact with the ground plate.

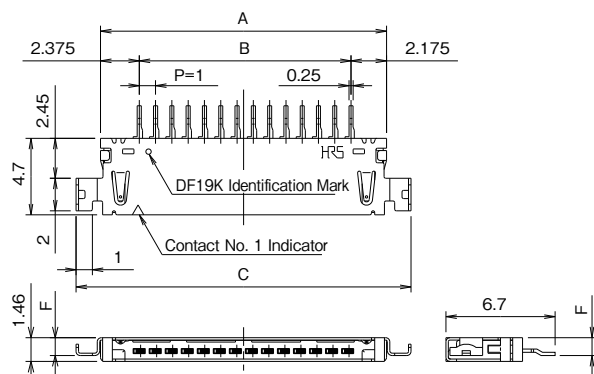
Unit : mm

Part No.	HRS No.	No. of Pos.	A	B	C	Remarks	Purchase Unit
DF19G-8P-1H(52)	CL0685-0021-0-52	8	11.55	7.0	11.95	1.65mm Height Above Board	1,000pcs per reel
DF19G-14P-1H(52)	CL0685-0004-0-52	14	17.55	13.0	17.95		
DF19G-20P-1H(52)	CL0685-0006-6-52	20	23.55	19.0	23.95		
DF19G-30P-1H(52)	CL0685-0015-7-52	30	33.55	29.0	33.95		

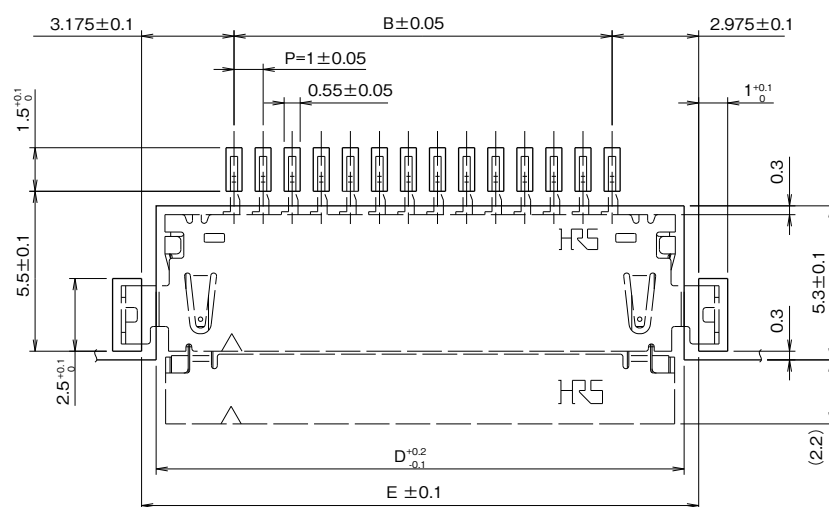
Right Angle Pin Header (SMT) (Offset Mounted Type)



Pictured mounted on board.



Recommended PCB Mounting Pattern



Unit : mm

Part No.	HRS No.	No. of Pos.	A	B	C	D	E	F	Remarks	Purchase Unit
DF19K-20P-1H(52)	CL0685-0008-1-52	20	23.55	19.0	26.55	24.15	25.15	1.0	1.0mm Height Above Board	1,000pcs per reel
DF19K-30P-1H(52)	CL0685-0032-6-52	30	33.55	29.0	36.55	34.15	35.15	1.0		
DF19L-14P-1H(52)	CL0685-0003-8-52	14	17.55	13.0	20.55	18.15	19.15	1.1	1.1mm Height Above Board	
DF19L-20P-1H(52)	CL0685-0019-8-52	20	23.55	19.0	26.55	24.15	25.15	1.1		
DF19L-30P-1H(52)	CL0685-0016-0-52	30	33.55	29.0	36.55	34.15	35.15	1.1		

Technical drawing of the 15H contact assembly, showing dimensions and labels:

- Top View:**
 - Overall width: 2.375
 - Overall height: 2.175
 - Internal width: B
 - Internal height: 2.45
 - Pin pitch: P=1
 - Pin diameter: 0.25
 - Label: 15H
 - Label: Contact No. 1 Indicator (pointing to a contact point)
 - Bottom width: C
 - Bottom height: 4.7
 - Bottom offset: 2
 - Bottom offset: 1
- Side View:**
 - Overall height: 1.46
 - Offset: 1
- Detail View:**
 - Width: 6.7
 - Offset: 1

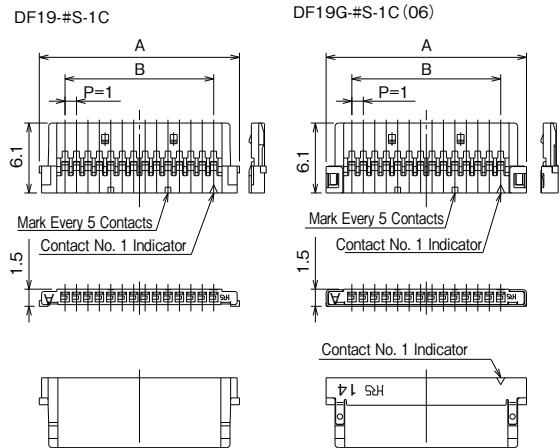
Technical drawing of a rectangular PCB layout. The drawing shows a top-down view of the board with various dimensions and component footprints. The overall dimensions are 3.175 ± 0.1 (width) and 5.3 ± 0.1 (height). The board is divided into sections with dimensions 1.5 ± 0.1, 2.5 ± 0.1, and 0.3. The central section has a width of 0.55 ± 0.05 and a height of 1 ± 0.1. The board is labeled with dimensions B ± 0.05 and E ± 0.1. The drawing includes several component footprints, including a large central footprint labeled 'D' with dimensions +0.2 / -0.1, and several smaller footprints labeled 'P' with dimensions 1 ± 0.05. The drawing also shows a series of small rectangular footprints along the bottom edge, labeled 'D' with dimensions +0.2 / -0.1. The drawing is a technical drawing of a PCB layout, showing dimensions and component footprints.

Part No.	HRS No.	No. of Pos.	A	B	C	D	E	Remarks	Purchase Unit
DF19KR-20P-1H(52)	CL0685-0023-5-52	20	23.55	19.0	26.55	24.15	25.15	1.0mm Height Above Board	1,000pcs per reel

Single Row Socket (Cable Type)



Shown with terminated and installed contacts



Unit : mm

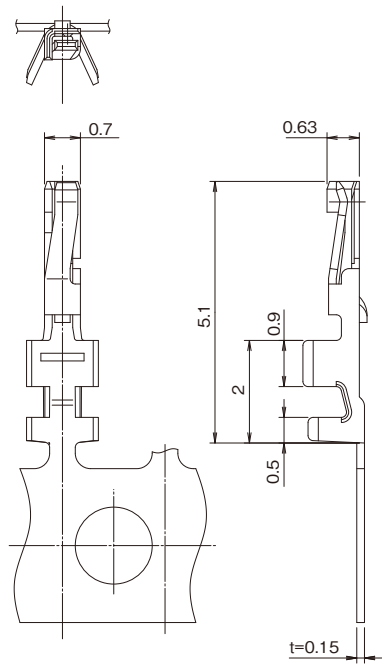
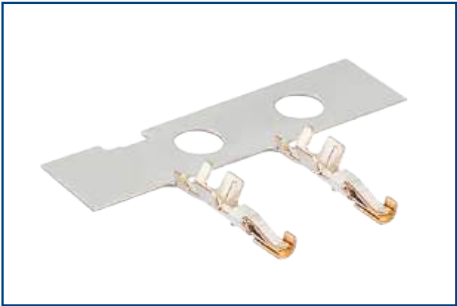
Part No.	HRS No.	No. of Pos.	A	B	Purchase Unit
DF19-14S-1C	CL0685-0012-9-00	14	17.5	13.0	100pcs per bag
DF19-20S-1C	CL0685-0011-6-00	20	23.5	19.0	
DF19-30S-1C	CL0685-0013-1-00	30	33.5	29.0	

With Exterior Shell (EMI Prevention Specification)

Unit : mm

Part No.	HRS No.	No. of Pos.	A	B	Purchase Unit
DF19G-8S-1C(06)	CL0685-0022-2-06	8	11.5	7.0	100pcs per bag
DF19G-14S-1C(06)	CL0685-0005-3-06	14	17.5	13.0	
DF19G-20S-1C(06)	CL0685-0007-9-06	20	23.5	19.0	
DF19G-30S-1C(06)	CL0685-0014-4-06	30	33.5	29.0	

Socket Crimp Contacts



Part No.	HRS No.	Purchase Unit (##): Blank	Purchase Unit (##): (41)
DF19A-2830SCFA(##)	CL0685-0048-6-##	10,000pcs per reel	20,000pcs per reel
DF19A-3032SCFA(##)	CL0685-0046-0-##		

Applicable Wire (Tin Plated Annealing Copper Wire)

Part No.	UL	Wire Size	Stranded Wire Structure	Sectional Area	Jacket Diameter	Strip Length
DF19A-2830SCFA(##)	1571 (Thin Type)	28 AWG	7/0.127mm	0.089mm ²	φ 0.5-0.6mm	1.2-1.9mm
		30 AWG	7/0.1mm	0.055mm ²		
DF19A-3032SCFA(##)		30 AWG 32 AWG	7/0.1mm 7/0.08mm	0.055mm ² 0.035mm ²		

Note: For applicable cable other than those listed above, refer to Crimp Condition Table. Crimp Condition Table is available from Part No. link.
(If you are using a cable that is not listed in Crimp Condition Table, please contact a Hirose sales representative.)

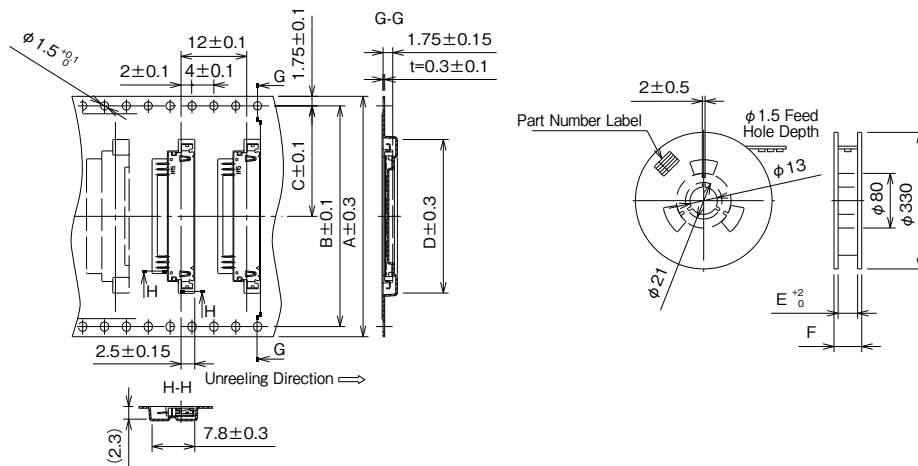
Applicable Tools

Type	Part No.	HRS No.	Applicable Contact
Applicator	AP105-DF19S	CL0901-4571-3-00	DF19A-2830SCFA(##) DF19A-3032SCFA(##)
Press Unit	CM-105C	CL0901-0001-0-00	-

Note 1: Please conduct crimping work according to the "Crimping Quality Standard" and "Crimping Condition Table".
Note 2: Issues with non-Hirose specified tools are outside the scope of warranty.
Note 3: When non-authorized tools are used, please consult with Hirose sales representative about provision of the drawing of the crimping tool.

Embossed Carrier Tape Dimensions (JIS-C-0806 Standard)

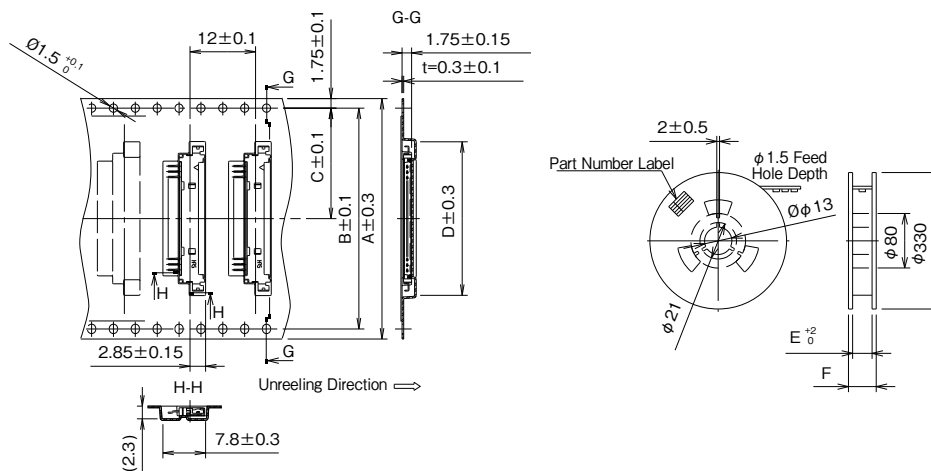
- DF19G-#P-1H(52)
- DF19K-#P-1H(52)
- DF19L-#P-1H(52)



Unit : mm

Part No.	No. of Pos.	A	B	C	D	E	F	Remarks
DF19G-8P-1H(52)	8	24.0	-	11.5	16.1	24.4	30.4	Top-board Mounted (1.65mm Height)
DF19G-14P-1H(52)	14	44.0	40.4	20.2	22.1	44.4	50.4	
DF19G-20P-1H(52)	20	44.0	40.4	20.2	28.1	44.4	50.4	
DF19G-30P-1H(52)	30	56.0	50.2	26.2	38.1	56.4	62.4	
DF19K-20P-1H(52)	20	44.0	40.4	20.2	28.1	44.4	50.4	Offset Mounted (1.0mm Height)
DF19K-30P-1H(52)	30	56.0	52.4	26.2	38.1	56.4	62.4	
DF19L-14P-1H(52)	14	44.0	40.4	20.2	22.1	44.4	50.4	Offset Mounted (1.1mm Height)
DF19L-20P-1H(52)	20	44.0	40.4	20.2	28.1	44.4	50.4	
DF19L-30P-1H(52)	30	56.0	52.4	26.2	38.1	56.4	62.4	

- DF19KR-20P-1H(52)



Unit : mm

Part No.	No. of Pos.	A	B	C	D	E	F	Remarks
DF19KR-20P-1H(52)	20	44.0	40.4	20.2	28.1	44.4	50.4	Reverse type of DF19K Offset Mounted (1.0mm Height)

Crimping Precautions

■ Items Required Prior to Crimping

The work-related documents shown below are required before starting harness assembly.

(The ● mark represents required documents.)

Please contact your Hirose sales representative if you do not have these documents.

Document Title	Description	Automatic Crimping Machine	Hand Crimping Tool	Remarks
① Crimping Machine Main Unit Instruction Manual	Explanation of main press unit	●	-	Bundled with purchase of main press machine unit.
② Applicator Instruction Manual	Crimp Method	●	-	Bundled with purchase of applicator.
③ Applicator Spare Parts List	Applicator Installation Instruction	●	-	
④ Crimp Conditions	Crimp height, tensile strength standard value	●	-	
⑤ Crimp Quality Standards	Various standards for crimping conditions	●	-	
⑥ Hand Tool Operating Instructions	Crimp method, crimp height and tensile height standard value	-	●	Bundled with purchase of hand tool.
⑦ Cable Assembly Instruction	Cable assembly	●	●	Please refer to our website.

■ Tools

- Use tools designated by Hirose when crimping.
- Crimping performed using tools other than those specified is outside the scope of warranty.
- The operating instructions are available for the crimping machine and the applicator. Be sure to carefully read the operating instructions manual before beginning work.

■ Applicable Cables

Refer to Crimp Condition Table when using cables other than applicable wire. Crimp Condition Table is available from Part No. link.

(If you are using a cable that is not listed in Crimp Condition Table, please contact a Hirose sales representative.)

[Precautions]

- Cables applicable to crimping connectors are tin-plated stranded soft-copper wire.
- Avoid crimping solid wire, wires with polyester threads or tin coated wires.
- Avoid crimping two cables together.
- The crimp height setting values (Note) may vary between tin-plated and gold-plated terminals even if the same electric wires are used.
- The crimp height setting values (Note) may vary depending on the difference in the core wire configuration even if the computed cross-sectional area is the same.

Note: The crimp height is an important item that determines crimping quality. We execute crimping tests for each electric wire to ensure the optimal value for the crimp height with high precision, thereby ensuring optimal setup values.

Precautions

1. Recommended Temperature Profile	Temperature (°C) Note 1: Up to 2 cycles of reflow soldering are possible under the same conditions, provided that there is a return to normal temperature between the first and second cycle. Note 2: The temperature profile indicates the temperature of the surface of the connector lead. Note 3: The color of the grounding plate may change color, although this does not affect the product performance.
2. Recommended Manual Soldering Conditions	Manual soldering: 350±10°C for 5 seconds
3. Recommended Metal Mask Thickness	0.15mm
4. Board Warpage	Maximum of 0.03mm at the connector center, with both ends of the connector as reference points.
5. Cleaning Conditions	Refer to "Product Guidelines (Board-to-Wire Connector Guidelines)"
6. Termination Conditions	Refer to "Product Guidelines (Board-to-Wire Connector Guidelines)"
7. Cautions	- Excessive prying during mating and unmating may result in damage. - Black spots may appear on the mold resin but this does not affect the product quality.
8. Handling	Please refer to the materials listed below on our company website when handling this product. - Product Guidelines (Board-to-Wire Connector Guidelines) - Crimp Condition Table - Crimp Quality Standard

While Taking into Consideration

Specifications mentioned in this catalog are reference values.

When considering to order or use this product, please review the Drawing and Product Specifications sheets.

Use an appropriate cable when using the connector in combination with cables.

If considering usage of a non-specified cable, please contact your sales representative.

If assembly process is done by jigs & tools which are not identified by Hirose, the warranty of the product may be affected.

If considering usage for below mentioned applications, please contact your sales representative.

In cases where the application will demand a high level of reliability, such as automotive, medical instruments, public infrastructure, aerospace/ defense etc. Hirose must review before assurance of reliability can be given.